

Customer Information Notification

Issue Date: 27-Jun-2018 Effective Date: 28-Jun-2018

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2018050131



Change Category			
] Wafer Fab Process	[] Assembly [] Product Marking	[] Test	[] Design
	Process	Location	
] Wafer Fab Materials	[] Assembly [] Mechanical	[]Test	[X] Errata
	Materials Specification	Process	
1 Wafer Fab Location	[] Assembly []	[] Test	[X] Electrical

| Wafer Fab Location | [] Assembly [] | [] Lest | [X] Electrica Location Packing/Shipping/Labeling Equipment spec./Test coverage

[] Other

S32R274 Reference Manual, Datasheet, and Errata Update

Description

[] Firmware

NXP Semiconductors announces Reference Manual, Data Sheet, and Errata update for the S23R274 mask 2N58R. Each document provides a detailed description of the changes in the revision history.

Reference Manual update from Revision 3.1 to Revision 4 Datasheet update from Revision 3.2 to Revision 4 Errata update from Revision 1 to Revision 2

The new revision of the Reference Manual, Data Sheet, and Errata can be found at: https://www.nxp.com/products/processors-and-microcontrollers/power-architecture-processors/mpc5xxx-55xx-32-bit-mcus/ultra-reliable-mpc57xx-32-bit-automotive-and-industrial-microcontrollers-mcus/s32r-radar-microcontroller-s32r27-automotive-industrial-radar-applications:S32R27?tab=Documentation_Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02 Reason

Reference Manual, Data Sheet, and Errata for the S23R274 mask 2N58R have been updated to provide additional technical clarification on some device features. Per Discontinuation Notification 201805003DN issued on 15June2018, part numbers FS32R274KBK2MMM/R and FS32R274KBK2VMM are removed from Revision 4 Reference Manual and Revision 4 Datasheet and replaced with FS32R274KSK2MMM/R and FS32R274KSK2VMM, respectively.

Identification of Affected Products

Top side marking

Part numbers listed in Table 2 of Revision 4 Datasheet with top side date code WW20 2018 (format xxx1820x) and later will comply to the SSCM module changes outlined in Appendix A.63.2 in the Revision 4 Reference Manual.

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Customers to assess potential hardware/software implications specific to device usage.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Existing inventory will be shipped until depleted

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Changed Orderable Part# Changed Part 12NC Changed Part Number Changed Part Description Package Outline Package Name Status Product Line FS32R274KBK2MMM 935350813557 FS32R274KBK2MMM 2M Flash, 1.5MB SRAM, 2x SOT1547-1 LFBGA257 RFS BL Auto Micro Processors